MA3S132A (MA132A), MA3S132K (MA132K)

Silicon epitaxial planar type

For switching circuits

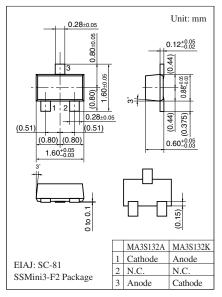
■ Features

- Short reverse recovery time t_{rr}
- Small terminal capacitance C_t
- Allowing high-density mounting

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Reverse voltage	V_R	80	V
Maximum peak reverse voltage	V_{RM}	80	V
Forward current	I_{F}	100	mA
Peak forward current	I_{FM}	225	mA
Non-repetitive peak forward surge current *	I_{FSM}	500	mA
Junction temperature	T _j	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

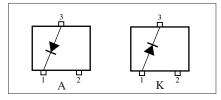
Note) *: t = 1 s



Marking Symbol:

MA3S132A: MB
 MA3S132K: MI

Internal Connection

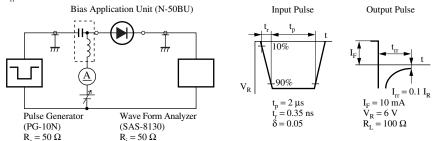


■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\rm F}$	$I_F = 100 \text{ mA}$			1.2	V
Reverse voltage	V _R	$I_R = 100 \mu A$	80			V
Reverse current	I_R	$V_R = 75 \text{ V}$			100	nA
Terminal capacitance	C _t	$V_R = 0 \text{ V, } f = 1 \text{ MHz}$			2	pF
Reverse recovery time *	t _{rr}	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}$			3	ns
		$I_{rr} = 0.1 I_R, R_L = 100 \Omega$				

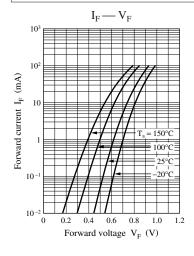
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

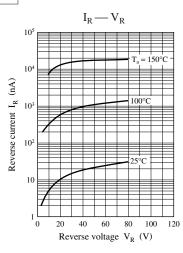
- 2. Absolute frequency of input and output is 100 MHz.
- 3. *: t_{rr} measurement circuit

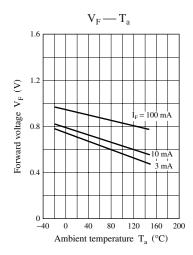


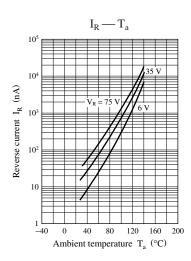
Note) The part numbers in the parenthesis show conventional part number.

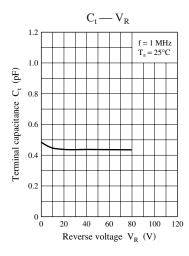
Characteristics charts of MA3S132A

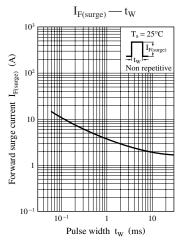




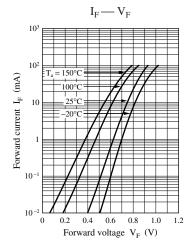


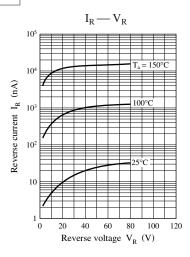


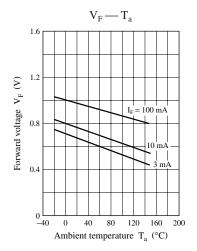


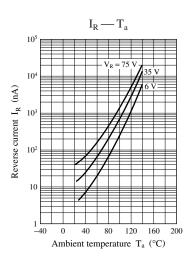


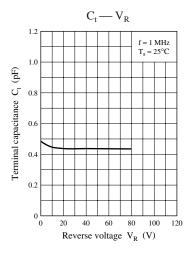
Characteristics charts of MA3S132K

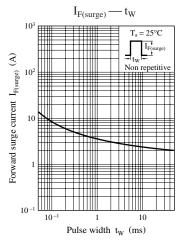












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